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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Donald Craig Foster RECEIVED
Assignee: Amkor Technology, Inc. OCT 16 2001
Title: Semiconductor Package And Leadframe With Horizontal Leads Spaced
In The Vertical Direction And Method Of Making
Serial No.: 09/932,290 Filing Date: August 17, 2001
Docket No.: M-11313 US

San Jose, California
October 8, 2001

COMMISSIONER FOR PATENTS
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR § 1.97(b)

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, the documents listed on the accompanying form PTO-1449 are called to the attention of the Examiner for the above patent application. Copies of these documents are enclosed.

Citation of these documents shall not be construed as:

1. an admission that the documents are necessarily prior art with respect to the instant invention;
2. a representation that a search has been made, other than as described above; or
3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on October 8, 2001.

[Signature]
Attorney for Applicant

10-8-01
Date of Signature

Respectfully submitted,

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U.S. Department of Commerce, Patent and Trademark Office					Atty Docket No.		Serial No.	
					M-11313 US		09/932,290	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT					Applicant: Donald Craig Foster			
(Use several sheets if necessary)					Filing Date: August 17, 2001			
					Group:			
U.S. Patent Documents								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	5,521,429	05/28/96	Aono et al.	257	676		
	AB	5,977,630	11/02/99	Woodworth et al.	257	712		
	AC	6,025,640	02/15/00	Yagi et al.	257	666		
	AD	6,130,115	10/10/00	Okumura et al.	438	124		
	AE	6,143,981	11/07/00	Glenn	174	52.4		
	AF	6,198,171 B1	03/06/01	Huang et al.	257	787		
	AG	6,225,146 B1	05/01/01	Yamaguchi et al.	438	123		
	AH	6,242,281 B1	06/06/01	McLellan et al.	438	106		
	AI	6,281,568 B1	08/28/01	Glenn et al.	257	684		
Foreign Patent Documents								
							Translation	
		Document	Date	Country	Class	Subclass	Yes	No
/	AJ	59-227143	12/20/84	Japan			X	
/	AK	60-195957	10/04/85	Japan			X	
/	AL	DE19734794A1	07/16/98	Germany				X
/	AM	EP0794572A2	10/09/97	Europe			X	
/	AN	7-312405	11/28/95	Japan			X	
/	AO	8-125066	05/17/96	Japan			X	
/	AP	8-306853	11/22/96	Japan			X	
/	AQ	9-8205	01/10/97	Japan			X	
/	AR	9-8206	01/10/97	Japan			X	
/	AS	9-8207	01/10/97	Japan			X	
/	AT	9-92775	04/04/97	Japan			X	
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)								
	AU							
Examiner				Date Considered				
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.								